

## Key Parameters

$V_{DRM}$	=	2000 V
$I_{TAVM}$	=	1200 A
$t_q$	=	60 $\mu$ s
$I_{TSM}$	=	15000 A
$V_{TO}$	=	1.25 V
$r_T$	=	0.430 m $\Omega$

# Fast Switching Thyristor

## 5STF 08F2060

Doc. No. 5SYA 1045-01 Apr.97

## Features

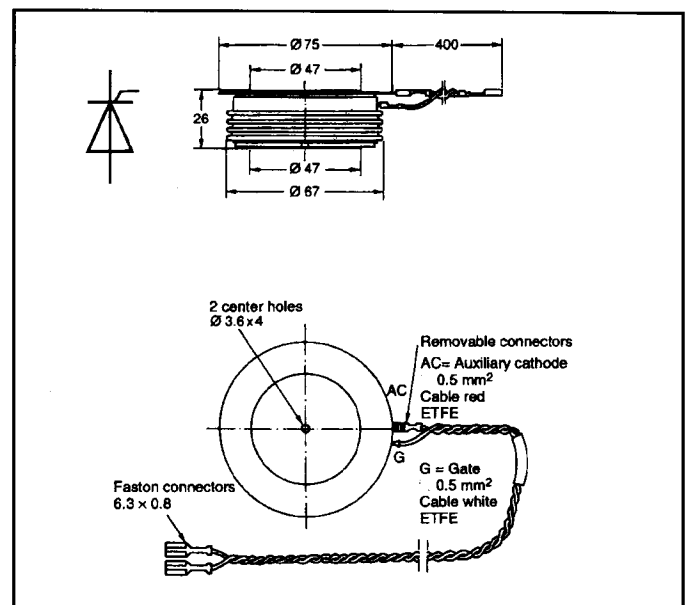
- Patented free-floating silicon technology
- Designed for traction and industrial applications
- Optimum switching performance

## Blocking

Part number	5STF 08F2060	5STF 08F1860	5STF 08F1460	Conditions
$V_{DRM}$ $V_{RRM}$	2000 V	1800 V	1400 V	$f = 50\text{Hz}$ , $t_p = 10\text{ms}$
$V_{RSM1}$	2100 V	1900 V	1500 V	$t_p = 5\text{ms}$ , single pulse
$I_{DRM}$	$\leq 150\text{ mA}$			$V_{DRM}$
$I_{RRM}$	$\leq 150\text{ mA}$			$V_{RRM}$
$dv/dt_{crit}$	1000 V/ $\mu$ s			@ Exp.to 0.67x $V_{DR}$
$T_{vj} = 125^\circ\text{C}$				

## Mechanical data

$F_m$	Mounting force	nom	22 kN
		min	14 kN
		max	24 kN
a	Acceleration Device clamped		100 m/s <sup>2</sup>
m	Weight		0.60 kg
$D_s$	Surface creepage distance		25 mm
$D_a$	Air strike distance		14 mm



## On-state

$I_{TAVM}$	Max. average on-state current	1200 A	Half sine wave, $T_c = 70^\circ\text{C}$	
$I_{TRMS}$	Max. RMS on-state current	1884 A		
$I_{TSM}$	Max. peak non-repetitive surge current	15000 A	$t_p = 10\text{ ms}$	$T_{vj} = 125^\circ\text{C}$
		A	$t_p = 8.3\text{ ms}$	
$Pt$	Limiting load integral	1125 kA <sup>2</sup> s	$t_p = 10\text{ ms}$	
		kA <sup>2</sup> s	$t_p = 8.3\text{ ms}$	
$V_T$	On-state voltage	2.10 V	$I_T = 2000\text{ A}$	
$V_{TO}$	Threshold voltage	1.25 V		
$r_T$	Slope resistance	0.430 m $\Omega$	$I_T = 600 - 1800\text{ A}$	
$I_H$	Holding current	30-70 mA	$T_{vj} = 25^\circ\text{C}$	
		15-50 mA	$T_{vj} = 125^\circ\text{C}$	
$I_L$	Latching current	150-600 mA	$T_{vj} = 25^\circ\text{C}$	
		75-400 mA	$T_{vj} = 125^\circ\text{C}$	

## Switching

$di/dt_{crit}$	Critical rate of rise of on-state current	300 A/ $\mu\text{s}$	Cont.	$V_D \leq 0.67 \times V_{DRM}$ $T_{vj} = 125^\circ\text{C}$ $I_{TRM} = 2000\text{ A}$ $f = 50\text{ Hz}$ $I_{FG} = 1.5\text{ A}$ $t_r = 0.5\mu\text{s}$
		600 A/ $\mu\text{s}$	60 sec.	
$t_d$	Delay time	$\leq 2.0\ \mu\text{s}$	$V_D = 0.4 \times V_{DRM}$	$I_{FG} = 1.5\text{ A}$ $t_r = 0.5\mu\text{s}$
$t_q$	Turn-off time	$\leq 60\ \mu\text{s}$	$V_D \leq 0.67 \times V_{DRM}$ $dv_D/dt = 20\text{ V}/\mu\text{s}$	$I_{TRM} = 2000\text{ A}$ $T_{vj} = 125^\circ\text{C}$ $V_R > 200\text{ V}$
Q	Recovery charge	min	350 $\mu\text{As}$	$di_T/dt = -20\text{ A}/\mu\text{s}$
		max	560 $\mu\text{As}$	

## Triggering

$V_{GT}$	Gate trigger voltage	4.0 V	$T_{vj} = 25^\circ\text{C}$
$I_{GT}$	Gate trigger current	400 mA	$T_{vj} = 25^\circ\text{C}$
$V_{GD}$	Gate non-trigger voltage	0.3 V	$V_D = 0.4 \times V_{DRM}$
$I_{GD}$	Gate non-trigger DC current	10 mA	$V_D = 0.4 \times V_{DRM}$
$V_{FGM}$	Peak forward gate voltage	20 V	
$I_{FGM}$	Peak forward gate current	5 A	
$V_{RGM}$	Peak reverse gate voltage	10 V	
$P_G$	Gate power losses	3 W	

**Thermal**

$T_{vj\ max}$	Max. junction temperature	125 °C	
$T_{vj\ stg}$	Storage temperature range	-40...150°C	
$R_{thJC}$	Thermal resistance junction to case	28 K/kW	Anode side cooled
		35 K/kW	Cathode side cooled
		15 K/kW	Double side cooled
$R_{thCH}$	Thermal resistance case to heat sink	20 K/kW	Single side cooled
		10 K/kW	Double side cooled

Analytical function for transient thermal impedance:

$$Z_{thJC} = \sum_{i=1}^n R_i(1 - e^{-t/\tau_i})$$

$i$	1	2	3	4
$R_i$ (K/W)	0.0046	0.0068	0.0027	0.0008
$\tau_i$ (s)	0.7682	0.1902	0.0078	0.0000

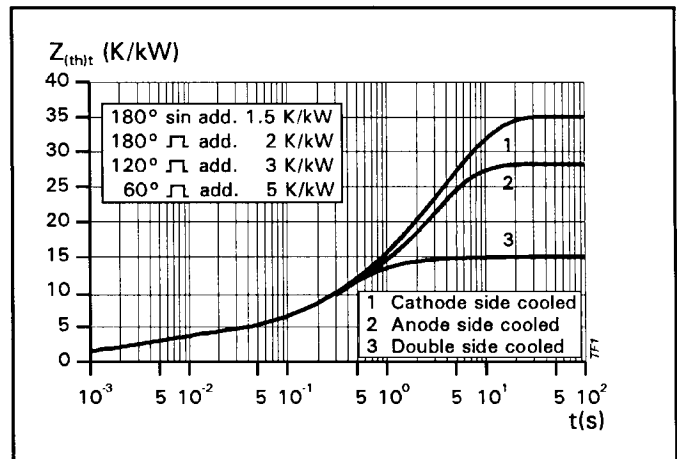


Fig.1 Transient thermal impedance, junction to case.

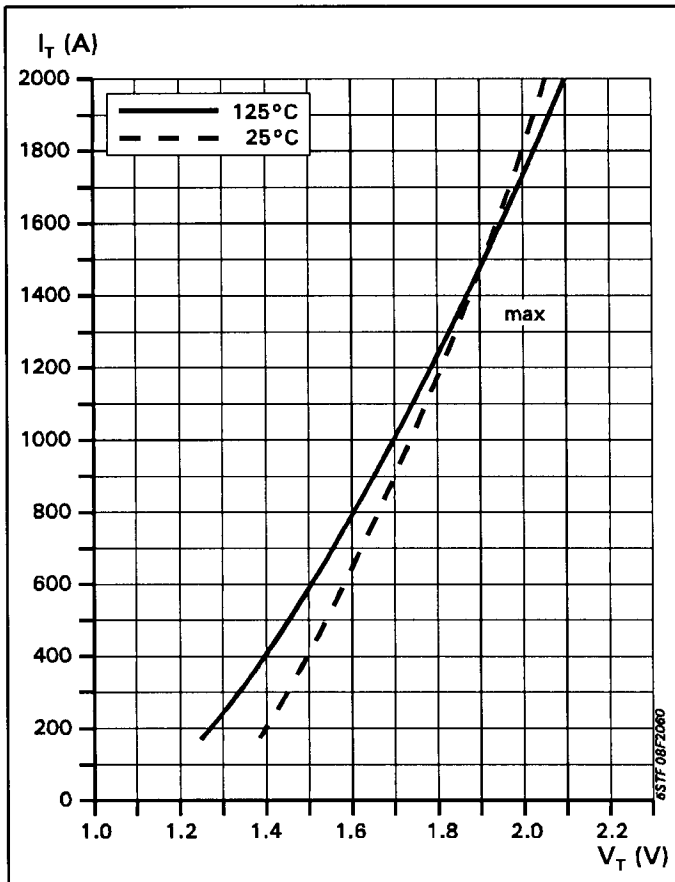


Fig.2 On-state characteristics.

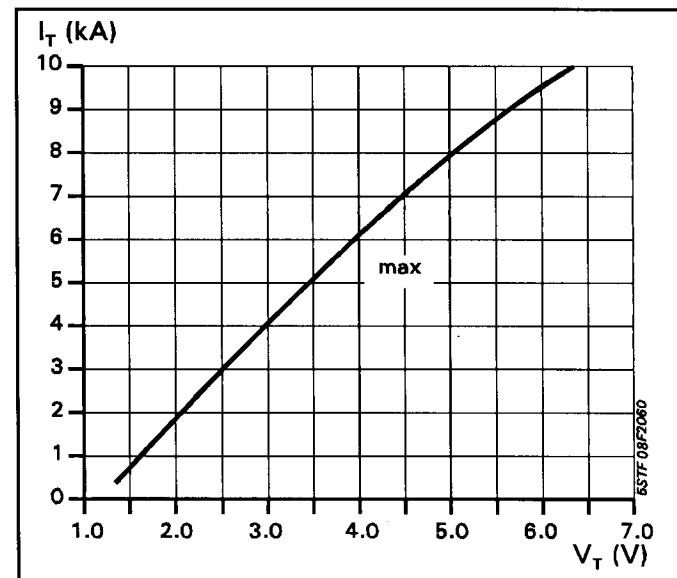


Fig.3 On-state characteristics.

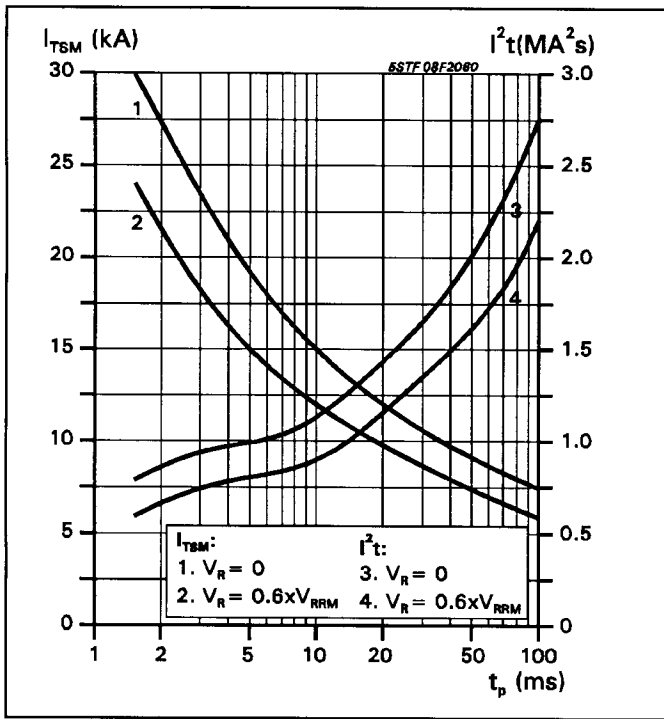


Fig.4 Surge on-state current vs pulse length. Half-sine wave.

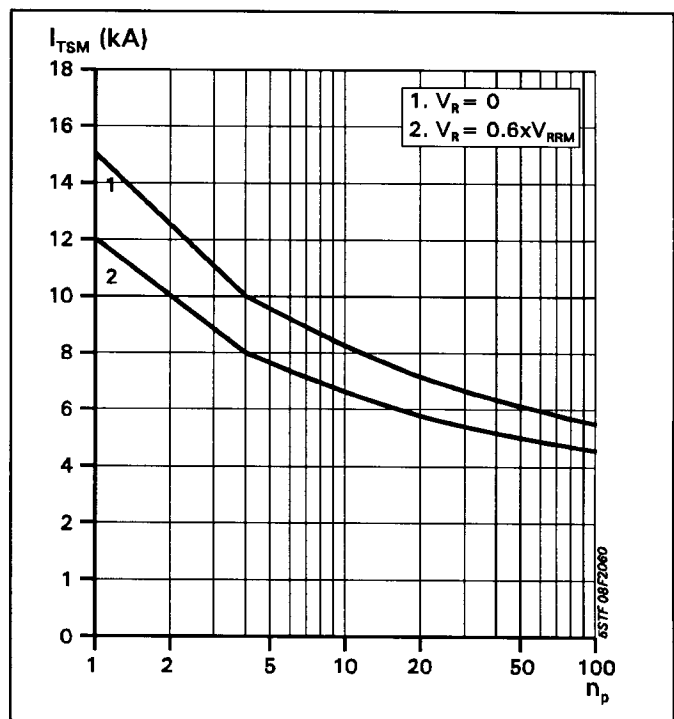


Fig.5 Surge on-state current vs number of pulses. Half-sine wave, 10ms, 50Hz.

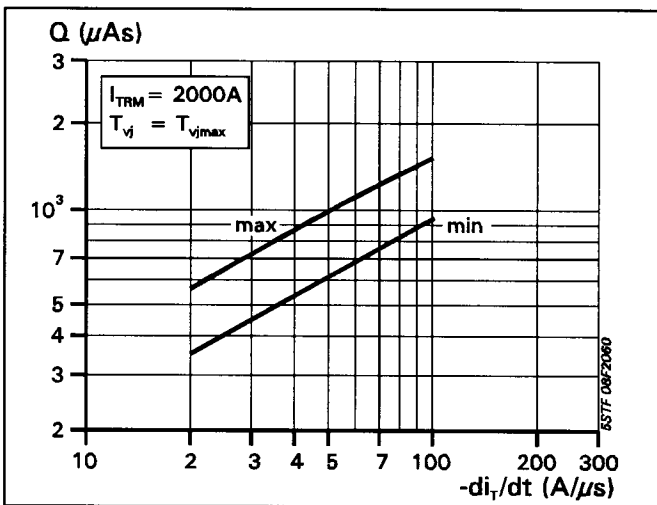


Fig.6 Recovery charge vs decay rate of on-state current.

